ASMT-QYBE-Nxxxx Super 0.5W Warm White Power PLCC-4 Surface Mount LED Indicator



Datasheet

Description

The Super 0.5W Warm White Power PLCC-4 SMT LED is first Warm white mid-Power PLCC-4 SMT LEDs using InGaN chip technology. The package can be driven at high current due to its superior package design. The product is able to dissipate the heat more efficiently compared to the Power PLCC-4 SMT LEDs. These LEDs produce higher light output with better flux performance compared to the Power PLCC-4 SMT LED.

The Super 0.5W Warm White Power PLCC-4 SMT LEDs are designed for higher reliability, better performance, and operate under a wide range of environmental conditions. The performance characteristics of these new mid-power LEDs make them uniquely suitable for use in harsh conditions such as in automotive applications, and in electronics signs and signals.

To facilitate easy pick and place assembly, the LEDs are packed in EIA-compliant tape and reel. Every reel is shipped in single intensity and color bin, to provide close uniformity. These LEDs are compatible with the IR solder reflow process.

Features

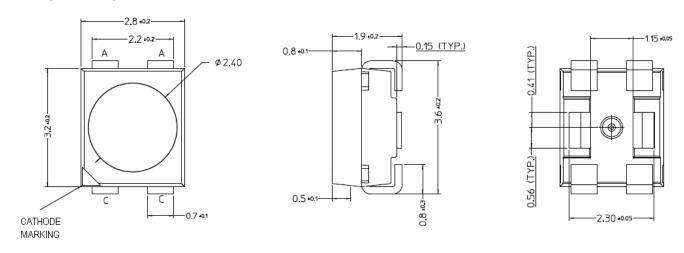
- Industry Standard PLCC 4 platform (3.2x2.8x1.9mm)
- High reliability LED package due to enhanced silicone resin material
- Mid-Power intensity brightness with optimum flux performance using InGaN chip technologies
- Available in Warm White
- Available in 8mm carrier tape & 7 inch reel
- Low Thermal Resistance 60°C/W
- Super wide viewing angle at 120 degree
- JEDEC MSL 2a

Applications

- 1. Interior automotive
 - a. Instrument panel backlighting
 - b. Central console backlighting
 - c. Navigation and audio system backlighting
 - d. Dome/Map lighting
 - e. Push button backlighting
 - f. Puddle lamp
 - g. Glove compartment illumination
- Exterior automotive
 - a. Number plate illumination
- 3. Electronic signs and signals
 - a. Decorative lighting
- 4. Office automation, home appliances, industrial equipment
 - a. Panel/button backlighting
 - b. Display backlighting

CAUTION: ASMT-QYBE-Nxxxx LEDs are Class 2 ESD sensitive. Please observe appropriate precautions during handling and processing. Refer to Avago Application Note AN-1142 for additional details.

Package Drawing



Note:

- All Dimensions in millimeters.
- Lead Polarity as shown in Figure 11. Terminal Finish: Ag plating
- Encapsulation material: Silicone resin

Figure 1. Package Drawing

Table 1. Device Selection Guide

			Luminous I			
Color	Part Number	Min. Flux	Typ. Flux	Max. Flux	Test Current	Dice Technology
		(lm)	(lm)	(lm)	(mA)	
Warm White	ASMT-QYBE-NEG0E	11.5	18.0	25.5	150	InGaN

Notes:

- Φ_V is the total luminous flux output as measured with an integrating sphere at mono pulse conditions.
- Tolerance = $\pm 12\%$

Part Numbering System

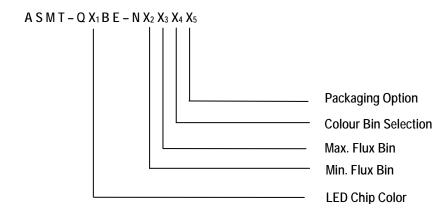


Table 2. Absolute Maximum Ratings (T_A = 25 °C)

Parameters	ASMT-QYBE-Nxxxx
DC Forward Current [1]	150 mA
Peak Forward Current [2]	300 mA
Power Dissipation	513 mW
Reverse Voltage	-4V
Junction Temperature	125 °C
Operating Temperature	-40 °C to +110 °C
Storage Temperature	-40 °C to +110 °C

Notes:

- 1. Derate Linearly as shown in Figure 6.
- 2. Duty Factor = 10%, Frequency = 1kHz

Table 3. Optical Characteristics (T_A = 25 °C)

Color	Part Number	Dice Technology	Typical Chromaticity Coordinates		Viewing Angle 20½ ^[1] (Degrees)	Luminous Efficacy ην ^[2] (Im/W)	Optical Efficiency η _{opt} (Im/W)	Total Flux / Luminous Intensity Φ _V (Im) / I _V (cd)
			Х	У	Тур.	Тур.	Тур.	Тур.
Warm White	ASMT-QYBE-Nxxxx	InGaN	0.437	0.413	120	375	33	2.75

Notes:

- 1. $\theta_{1/2}$ is the off-axis angle where the luminous intensity is 1/2 the peak intensity.
- 2. Radiant intensity, le in watts / steradian, may be calculated from the equation le = I_V / η_V , where I_V is the luminous intensity in candelas and η_V is the luminous efficacy in lumens / watt.

Table 4. Electrical Characteristics (T_A = 25 °C)

	Forward \	Thermal	
Part Number	(Volts) @ $I_F = 150 \text{ mA}$		Resistance
	Тур.	Max.	$R\theta_{J-P}$ (°C/W)
ASMT-QYBE-NEG0E	3.6	4.1	60

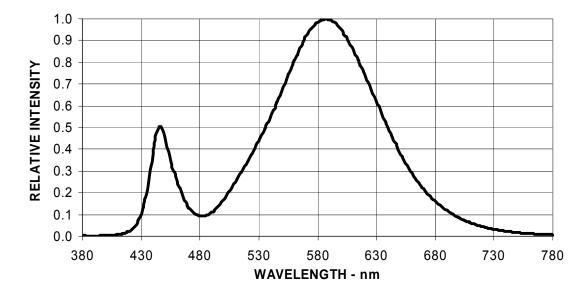


Figure 2. Relative Intensity Vs. Wavelength

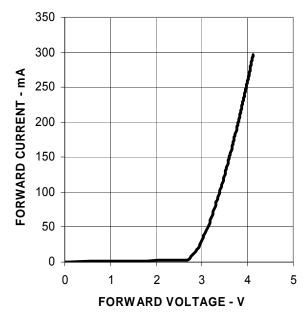


Figure 3. Forward Current Vs. Forward Voltage.

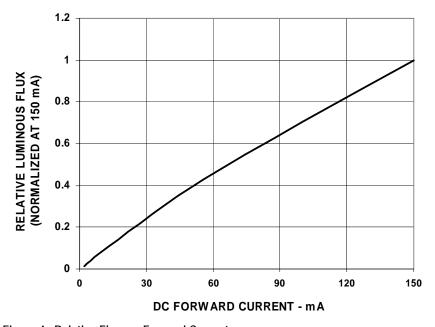


Figure 4. Relative Flux vs. Forward Current

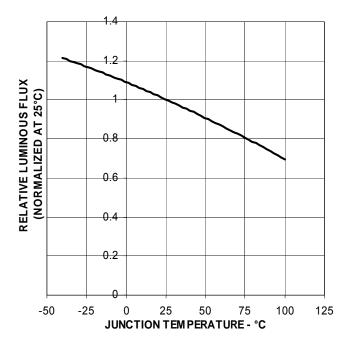


Figure 5. Relative Intensity Vs. Temperature

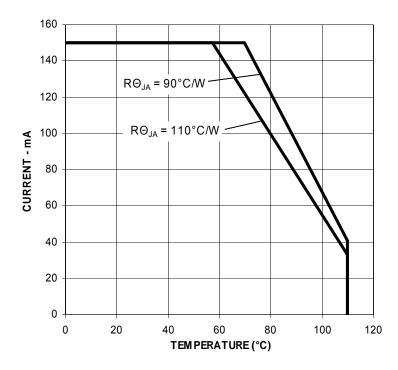


Figure 6a. Maximum Forward Current Vs. Ambient Temperature. Derated Based on T_{JMAX} = 125°C, $R\theta_{J-A}$ =110°C/W & 90°C/W.

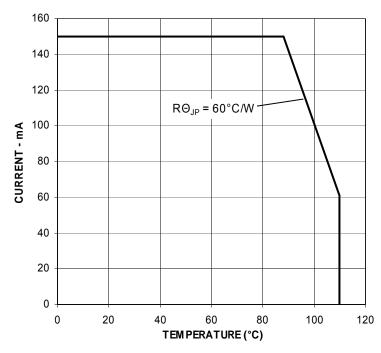


Figure 6b. Maximum Forward Current Vs. Solder Point Temperature. Derated Based on T_{JMAX} = 125°C, $R\theta_{J-P}$ =60°C/W.

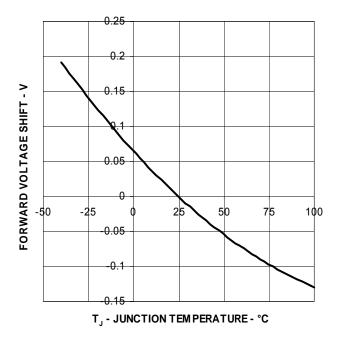


Figure 7. Forward Voltage Shift Vs. Temperature.

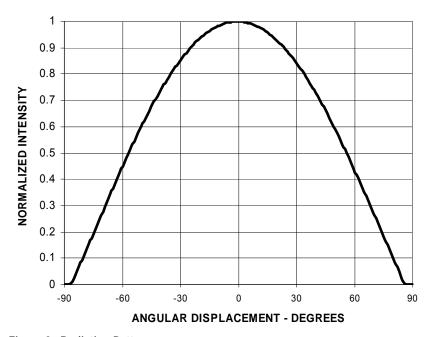
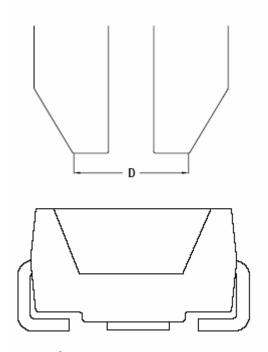


Figure 8. Radiation Pattern



Note: Diameter "D" should be smaller than 2.2mm

Figure 9. Recommended Pick and Place Nozzle Size

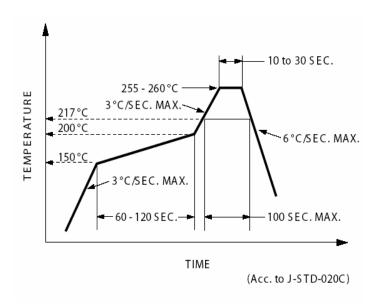


Figure 10. Recommended Pb-free Reflow Soldering Profile.

Note: For detail information on reflow soldering of Avago surface mount LEDs, do refer to Avago Application Note AN 1060 Surface Mounting SMT LED Indicator Components.

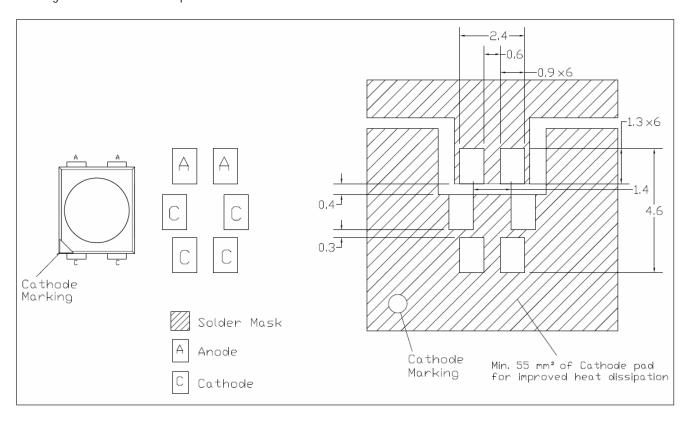


Figure 11. Recommended Soldering Pad Pattern.

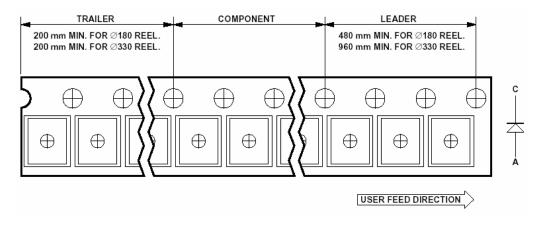


Figure 12. Tape Leader and Trailer Dimensions.

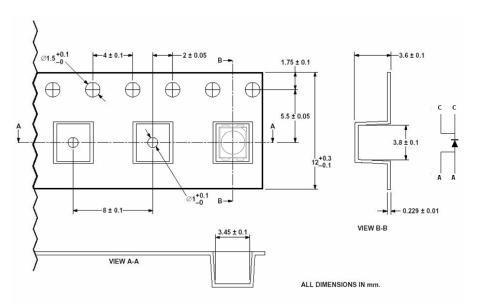


Figure 13. Tape Dimensions.

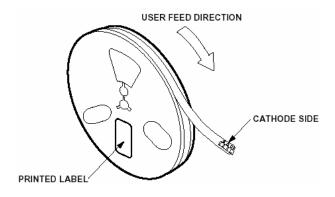


Figure 14. Reeling Orientation.

This product is qualified as Moisture Sensitive Level 2a per Jedec J-STD-020. Precautions when handling this moisture sensitive product is important to ensure the reliability of the product. Do refer to Avago Application Note AN5305 Handling of Moisture Sensitive Surface Mount Devices for details.

- A. Storage before use
- Unopen moisture barrier bag (MBB) can be stored at <40°C/90%RH for 12 months. If the actual shelf life has exceeded 12 months and the HIC indicates that baking is not required, then it is safe to reflow the LEDs per the original MSL rating.
 - It is not recommended to open the MBB prior to assembly (e.g. for IQC).
- B. Control after opening the MBB
 - The humidity indicator card (HIC) shall be read immediately upon opening of MBB.
- The LEDs must be kept at $<30^{\circ}$ C / 60%RH at all time and all high temperature related process including soldering, curing or rework need to be completed within 672 hours.
- C. Control for unfinished reel
 - For any unuse LEDs, they need to be stored in sealed MBB with desiccant or desiccator at <5%RH.
- D. Control of assembled boards
- If the PCB soldered with the LEDs is to be subjected to other high temperature processes, the PCB need to be stored in sealed MBB with desiccant or desiccator at <5%RH to ensure no LEDs have exceeded their floor life of 672 hours.
- E. Baking is required if:
 - "10%" or "15%" HIC indicator turns pink.
 - The LEDs are exposed to condition of >30°C / 60% RH at any time.
 - The LEDs floor life exceeded 672 hours.

Recommended baking condition: 60±5°C for 20 hours.

Device Color (X₁)

	\ ''/
Υ	Warm White

Flux Bin Select (X₂X₃)

Individual reel will contain parts from one bin only

X ₂	Min Flux Bin
X ₃	Max Flux Bin

Flux Bin Limits

Bin ID	Min. (lm)	Max. (Im)
0	3.40	4.30
Α	4.30	5.50
В	5.50	7.00
С	7.00	9.00
D	9.00	11.50
E	11.50	15.00
F	15.00	19.50
G	19.50	25.50
Н	25.50	33.00
ı	33.00	43.00
J	43.00	56.00
K	56.00	73.00

Tolerance of each bin limit = ± 12%

Color Bin Select (X₄)

Individual reel will contain parts from one sub bin only.

X_4	
0	Full Distribution
Α	H, J and K only
В	H, J, K, L and M only
С	L and M only
D	L, M, N and P only
E	N and P only
F	N, P, Q and R only
G	Q and R only
Z	Special Color Bin

Color Bin Limits

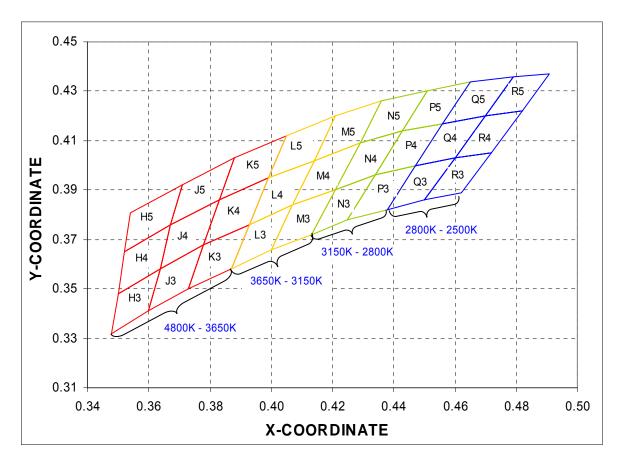
Bin ID	Sub Bin ID			its (Chromatici		
	НЗ	Х	0.348	0.360	0.364	0.350
		У	0.332	0.341	0.358	0.348
Н	H4	Х	0.350	0.364	0.367	0.352
		У	0.348	0.358	0.376	0.365
	H5	Х	0.352	0.367	0.371	0.354
	113	У	0.365	0.376	0.392	0.381
	J3	Х	0.360	0.373	0.378	0.364
	JS	У	0.341	0.350	0.368	0.358
	14	X	0.364	0.378	0.383	0.367
J	J4	у	0.358	0.368	0.386	0.376
		Х	0.367	0.383	0.388	0.371
	J5	у	0.376	0.386	0.403	0.392
		Х	0.373	0.387	0.393	0.378
	K3	У	0.350	0.358	0.376	0.368
	-	X	0.378	0.393	0.399	0.383
K	K4	<u>y</u>	0.368	0.376	0.395	0.386
	-	X	0.383	0.399	0.405	0.388
	K5	<u></u>	0.386	0.395	0.403	0.403
	L3	<u> </u>	0.387	0.400	0.407	0.393
		У	0.358	0.366	0.384	0.376
L	L4	Х	0.393	0.407	0.414	0.399
		у	0.376	0.384	0.402	0.395
	L5	X	0.399	0.414	0.421	0.405
		У	0.395	0.402	0.420	0.412
	M3	Х	0.400	0.413	0.421	0.407
		У	0.366	0.372	0.390	0.384
М	M4	X	0.407	0.421	0.429	0.414
		У	0.384	0.390	0.409	0.402
	M5	Х	0.414	0.429	0.436	0.421
	IVIO	У	0.402	0.409	0.426	0.420
	N3	Х	0.413	0.425	0.434	0.421
		У	0.372	0.378	0.396	0.390
N	N4	Х	0.421	0.434	0.443	0.429
11	114	У	0.390	0.396	0.414	0.409
	N5	х	0.429	0.443	0.451	0.436
	INO	У	0.409	0.414	0.430	0.426
	D2	Х	0.425	0.438	0.447	0.434
	P3	у	0.378	0.382	0.400	0.396
D	D4	Х	0.434	0.447	0.456	0.443
Р	P4	У	0.396	0.400	0.417	0.414
	DE	Х	0.443	0.456	0.465	0.451
	P5	у	0.414	0.417	0.434	0.430
		Х	0.438	0.450	0.460	0.447
	Q3	<u>y</u>	0.382	0.386	0.403	0.400
_	•	X	0.447	0.460	0.470	0.456
Q	Q4	<u></u>	0.400	0.403	0.420	0.430
	-	X	0.456	0.470	0.479	0.417
	Q5		0.430	0.420	0.436	0.403
		У	0.417	0.420	0.472	
	R3	X				0.460
		у	0.386	0.389	0.405	0.403
R	R4	X	0.460	0.472	0.482	0.470
		У	0.403	0.405	0.422	0.420
	R5	Х	0.470	0.482	0.491	0.479
	-	У	0.420	0.422	0.437	0.436

Tolerance of each bin limit = ± 0.02 .

For product information and a complete list of distributors, please go to our web site: www.avagotech.com

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V_F Bin Limits

1, 2 2						
Bin ID	Min.	Max.				
S5	3.20	3.50				
S6	3.50	3.80				
S7	3.80	4.10				

Tolerance of each bin limit = $\pm 0.1V$

Packaging Option (X₅)

Option	Test Current	Package Type	Reel Size
E	150mA	Top Mount	7 Inch

For product information and a complete list of distributors, please go to our web site: www.avagotech.com



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